MOSFET – Power, Single **N-Channel** 60 V. 21 mΩ. 25 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C682NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	60	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain		T _C = 25°C	I _D	25	Α
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		18	
Power Dissipation	State	T _C = 25°C	P _D	28	W
R _{θJC} (Note 1)		T _C = 100°C		14	
Continuous Drain		T _A = 25°C	I _D	8.8	Α
Current R _{θJA} (Notes 1, 2, 3)	Steady State	T _A = 100°C		6.2	
Power Dissipation		T _A = 25°C	P_{D}	3.5	W
R _{θJA} (Notes 1 & 2)		T _A = 100°C		1.7	
Pulsed Drain Current	$T_A = 25$	°C, t _p = 10 μs	I _{DM}	130	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	-55 to + 175	°C
Source Current (Body Diode)			IS	31	Α
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 1.1 \text{ A}$)			E _{AS}	43	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	5.3	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	43	

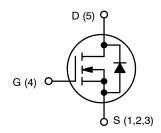
- 1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- 3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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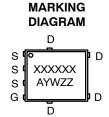
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	21 mΩ @ 10 V	25 A
00 V	31.5 m Ω @ 4.5 V	257



N-CHANNEL MOSFET



(SO-8FL) CASE 488AA STYLE 1



XXXXXX = 5C682L

(NVMFS5C682NL) or

682LWF

(NVMFS5C682NLWF) = Assembly Location

Α = Year W = Work Week ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•						•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				28		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25 °C			10	
		V _{DS} = 60 V	T _J = 125°C	C 250		μΑ	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 16 \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-4.5		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A		18	21	
		V _{GS} = 4.5 V	I _D = 10 A		26	31.5	mΩ
Forward Transconductance	9FS	V _{DS} =15 V, I _D = 10 A			17		S
CHARGES AND CAPACITANCES	•						•
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			410		pF
Output Capacitance	C _{OSS}				210		
Reverse Transfer Capacitance	C _{RSS}				7.0		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 48 V; I _D = 10 A			2.5		nC
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 10 A			5.0		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 10 A			0.6		nC
Gate-to-Source Charge	Q _{GS}				1.0		
Gate-to-Drain Charge	Q_{GD}				0.5		
Plateau Voltage	V _{GP}				2.7		V
SWITCHING CHARACTERISTICS (Note 5)				•	•	•
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 48 V, I_{D} = 10 A, R_{G} = 2.5 Ω			4.0		
Rise Time	t _r				12		- ns
Turn-Off Delay Time	t _{d(OFF)}				12		
Fall Time	t _f				1.5		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 10 A	T _J = 25°C		0.9	1.2	
			T _J = 125°C		0.8		
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, } dI_{S}/dt = 100 \text{ A/}\mu\text{s,}$ $I_{S} = 10 \text{ A}$			18		
Charge Time	ta				9.0		ns
Discharge Time	t _b				9.0		
Reverse Recovery Charge	Q _{RR}				7.0		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS

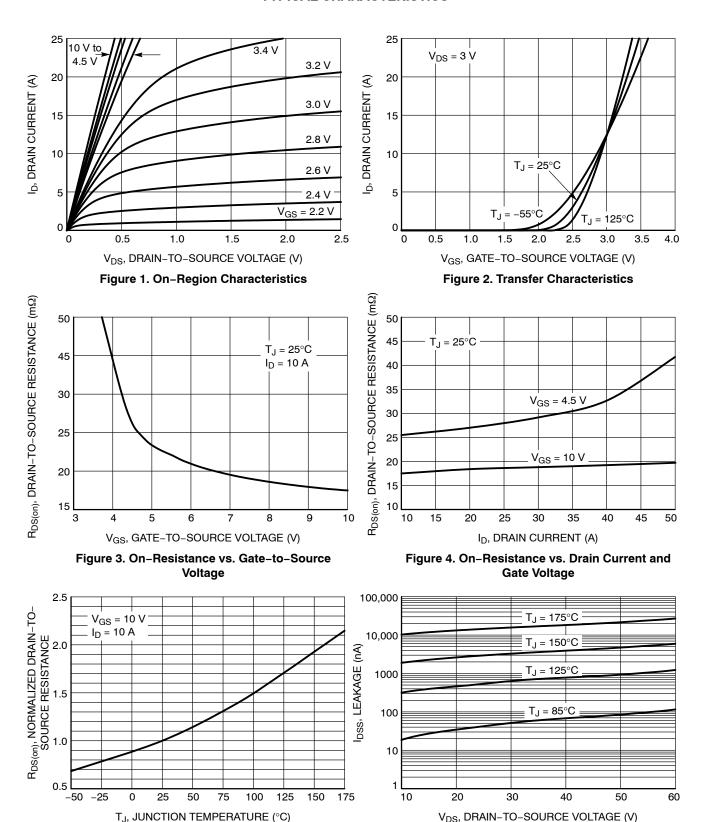


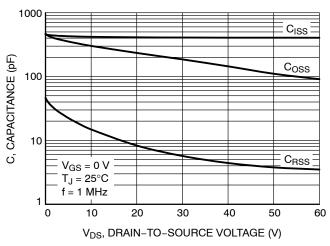
Figure 6. Drain-to-Source Leakage Current

vs. Voltage

Figure 5. On-Resistance Variation with

Temperature

TYPICAL CHARACTERISTICS

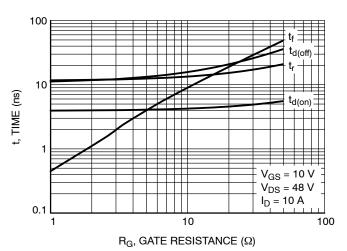


V_{GS}, GATE-TO-SOURCE VOLTAGE (V) 8 7 6 5 4 Q_{GS} Q_{GD} 3 $V_{DS} = 48 \text{ V}$ 2 T_J = 25°C $I_D = 10 A$ 0 2 Q_G, TOTAL GATE CHARGE (nC)

 Q_T

Figure 7. Capacitance Variation

Figure 8. Gate-to-Source vs. Total Charge



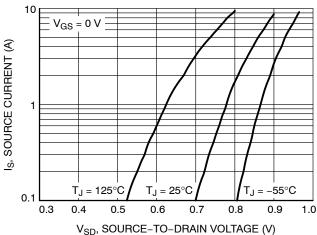
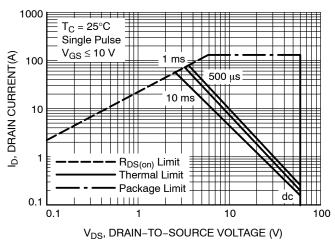


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

Figure 10. Diode Forward Voltage vs. Current



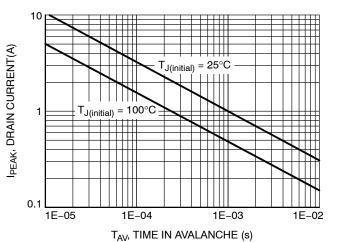


Figure 11. Maximum Rated Forward Biased Safe Operating Area

Figure 12. Maximum Drain Current vs. Time in **Avalanche**

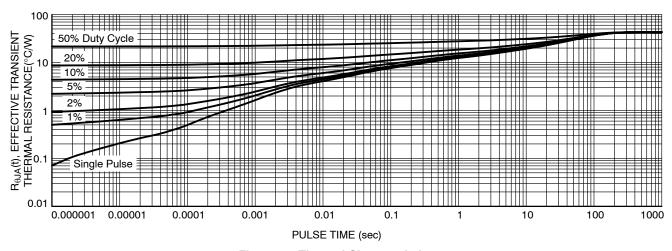


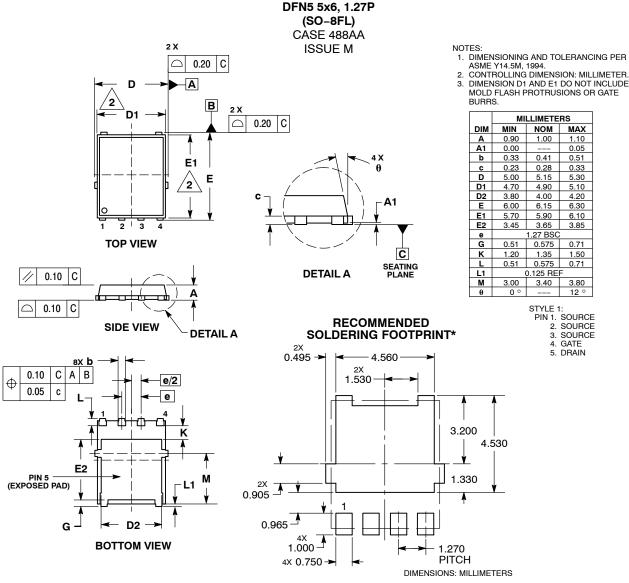
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]	
NVMFS5C682NLT1G	5C682L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C682NLWFT1G	682LWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	
NVMFS5C682NLT3G	5C682L	DFN5 (Pb-Free)	5000 / Tape & Reel	
NVMFS5C682NLWFT3G	682LWF	DFN5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel	
NVMFS5C682NLAFT1G	5C682L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C682NLWFAFT1G	682LWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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